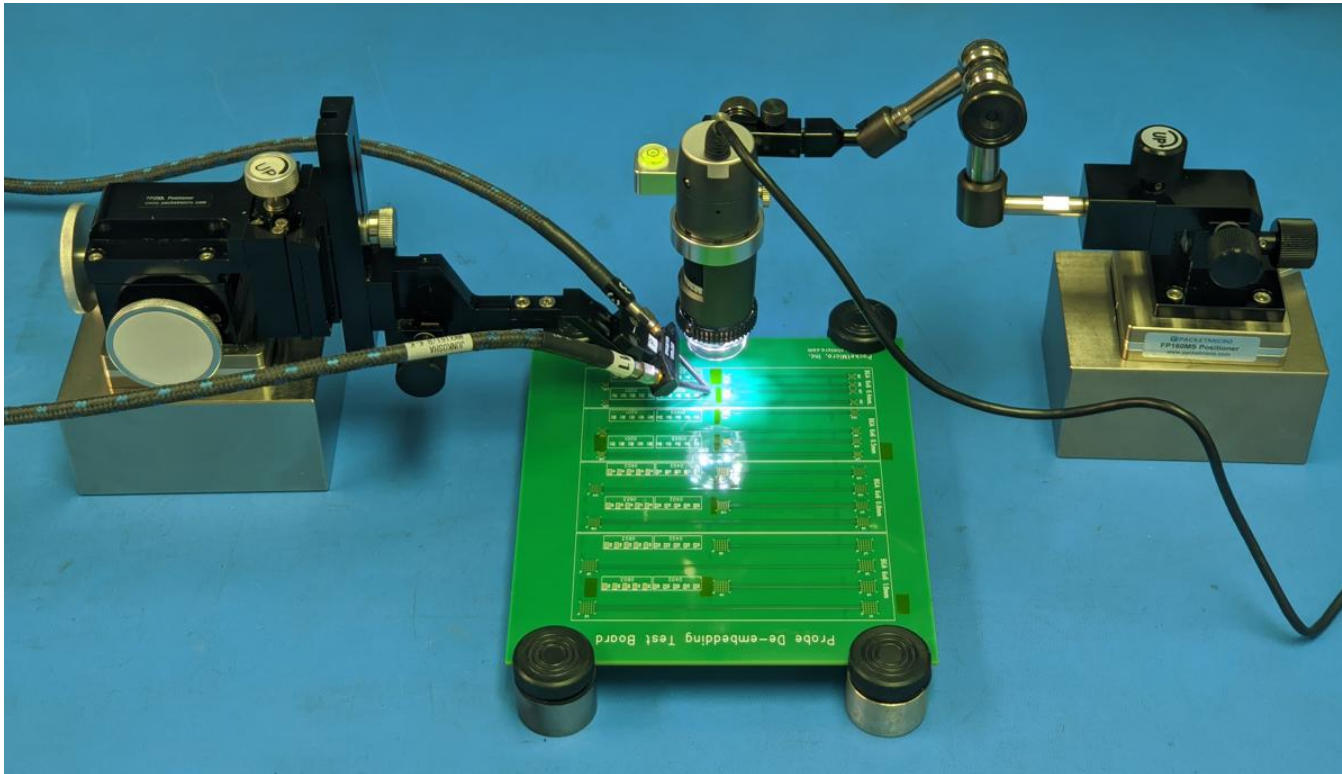


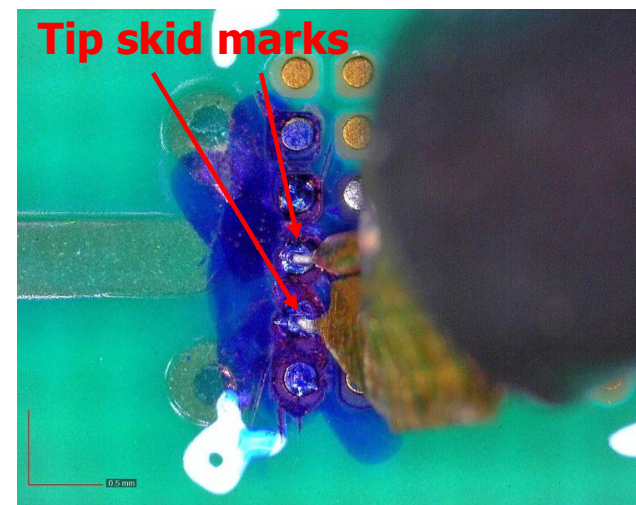
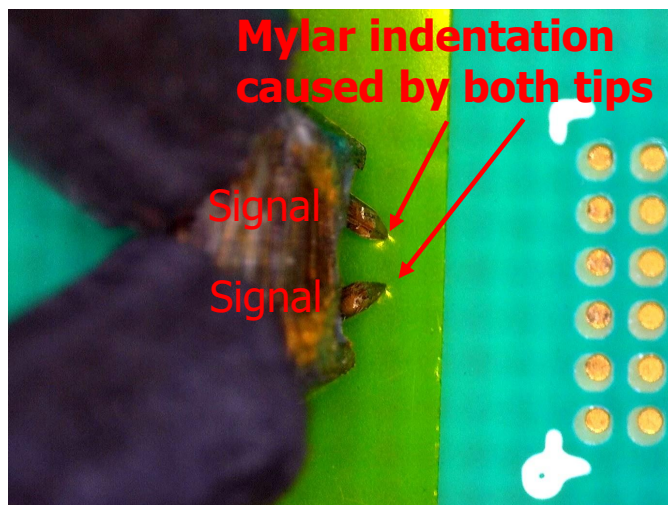
Probe Planarization

by using Mylar Tape and Marker



Probe Planarization Tips

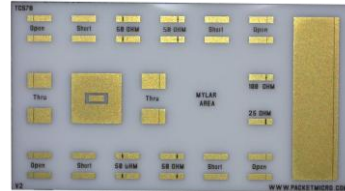
- Good contact of both probe tips with the DUT is essential to accurate calibration and measurements.
- Mylar tape provides leveling guidance on flat, even surface (bare PCB).
- Color marker helps on uneven surface (solder bumps).
- A good microscope is important. You may damage the probe if you cannot see its tips well.



Tools - Accessories



Optical Microscope
(~ 90 x magnification)



TCS70
Calibration
Substrate



Mylar
Tape



Fine-tip
Sharpie pen

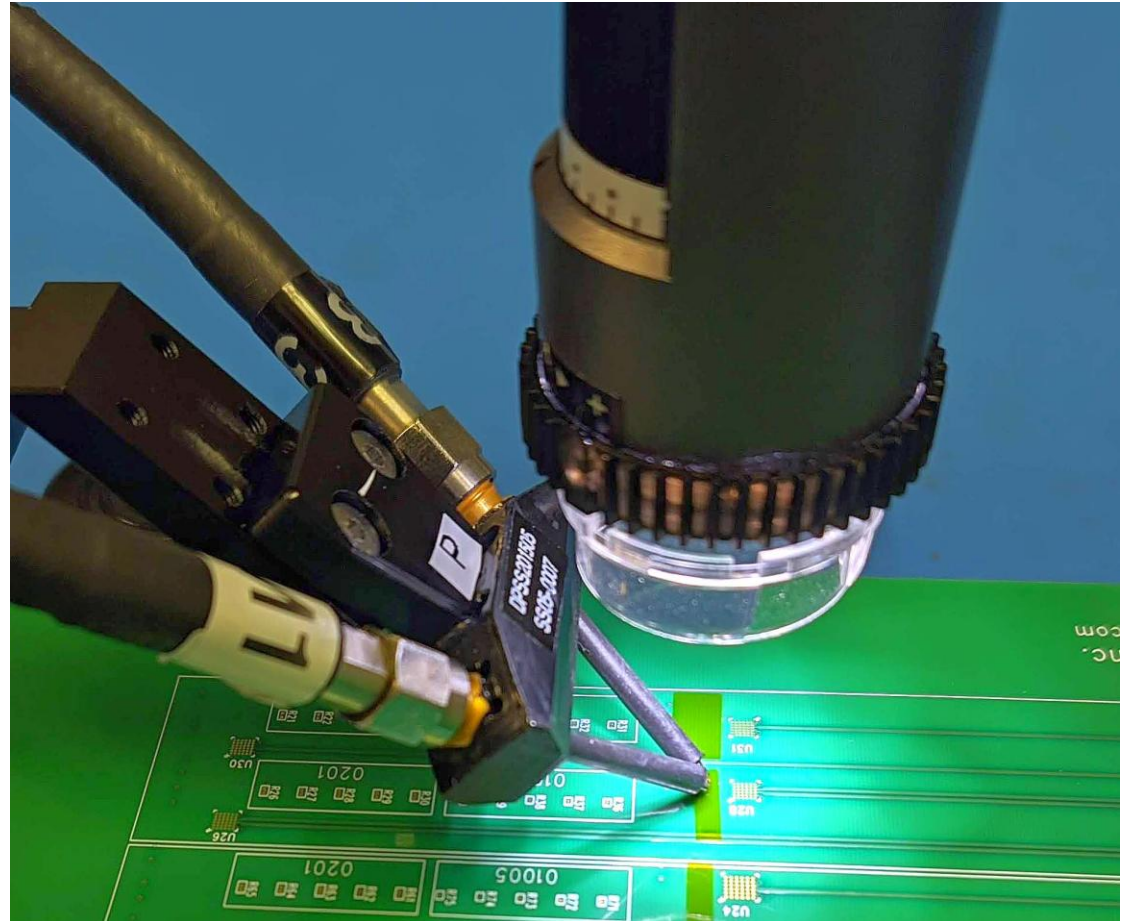
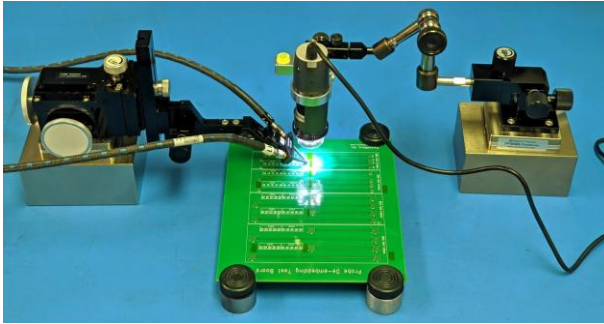


USB Digital Microscope
(~ 90 x magnification)

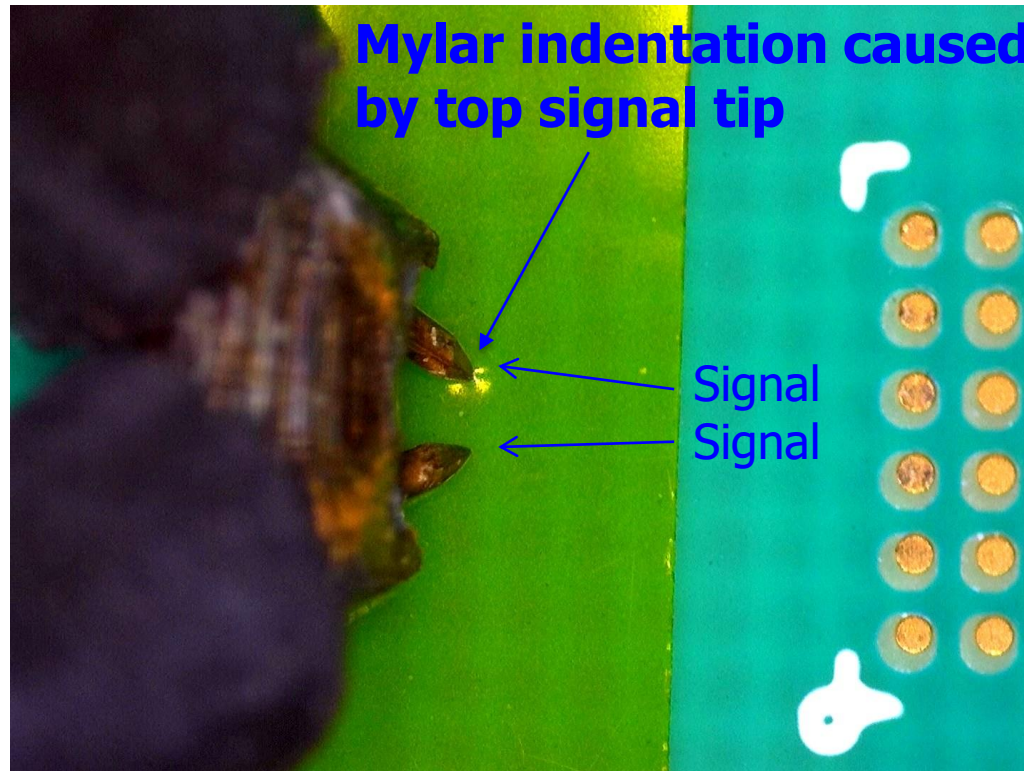
(Make sure to use a long working range (5 cm @ 90x) microscope!)

- Using a good microscope is essential.
- You might damage the probe if you cannot see its tips well.

Probe Planarization on Flat Surface



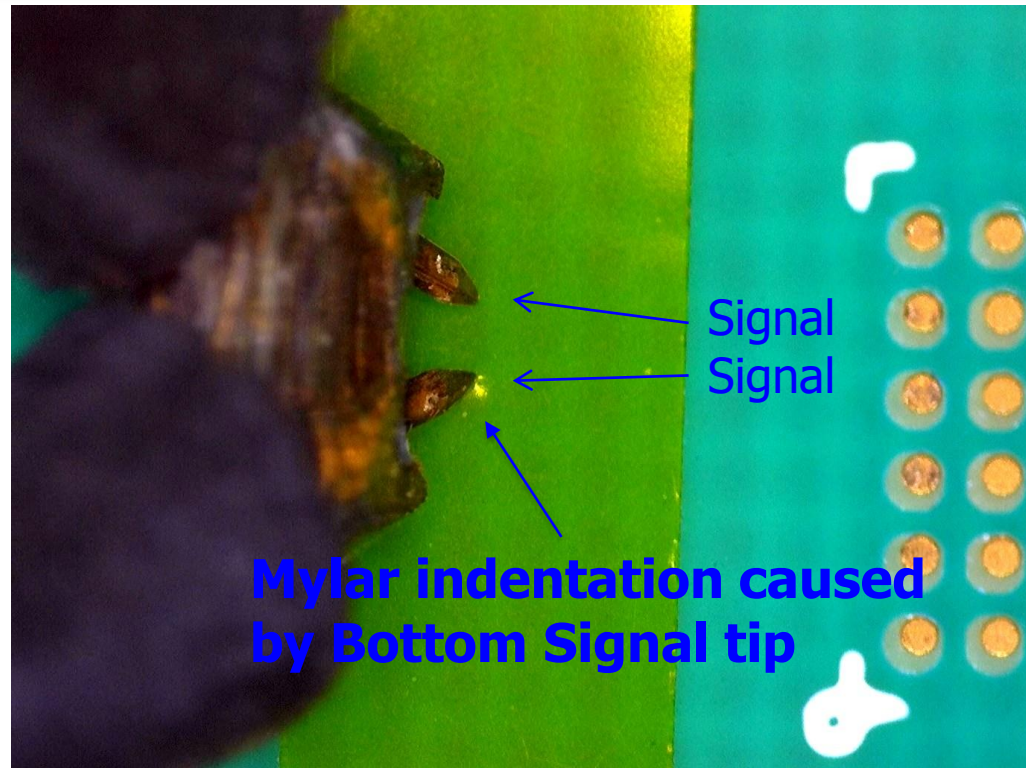
Top signal tip touches down first



Step 1:

Land the probe tips on the tape and observe the probe-tip footprint. Above image shows that top signal tip touches the surface first.

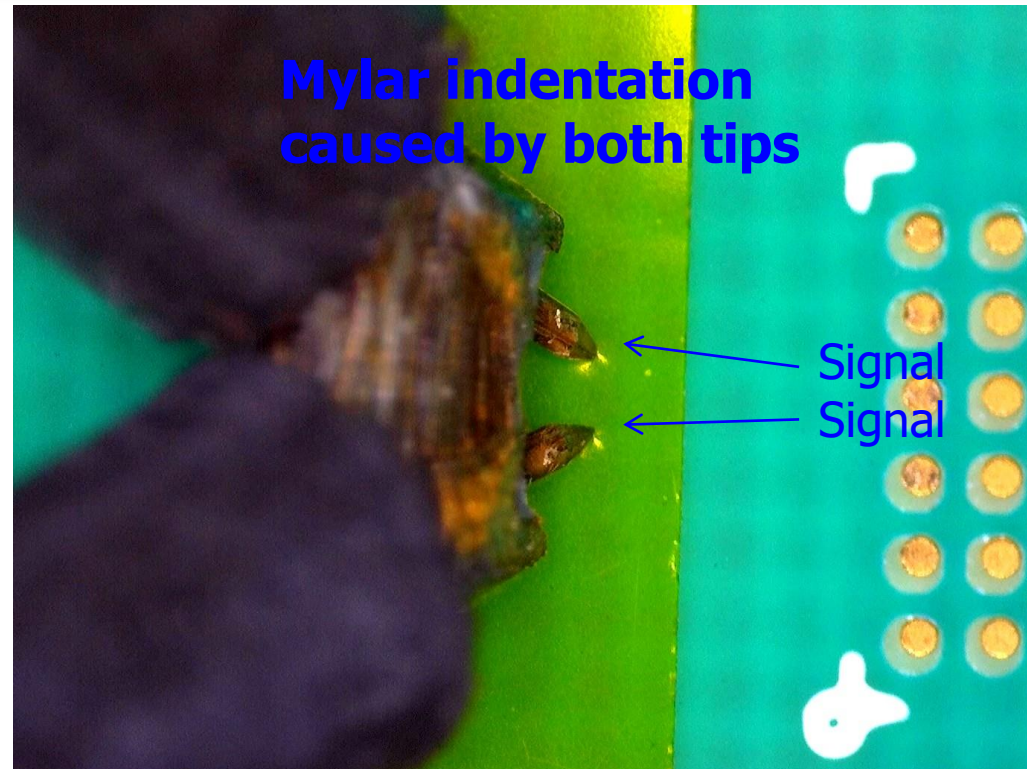
Bottom signal tip touches down first



Step 2:

Adjust the planarization knob on the TP250 positioner to level the bottom signal tip. Above image shows that bottom signal tip touches the surface first.

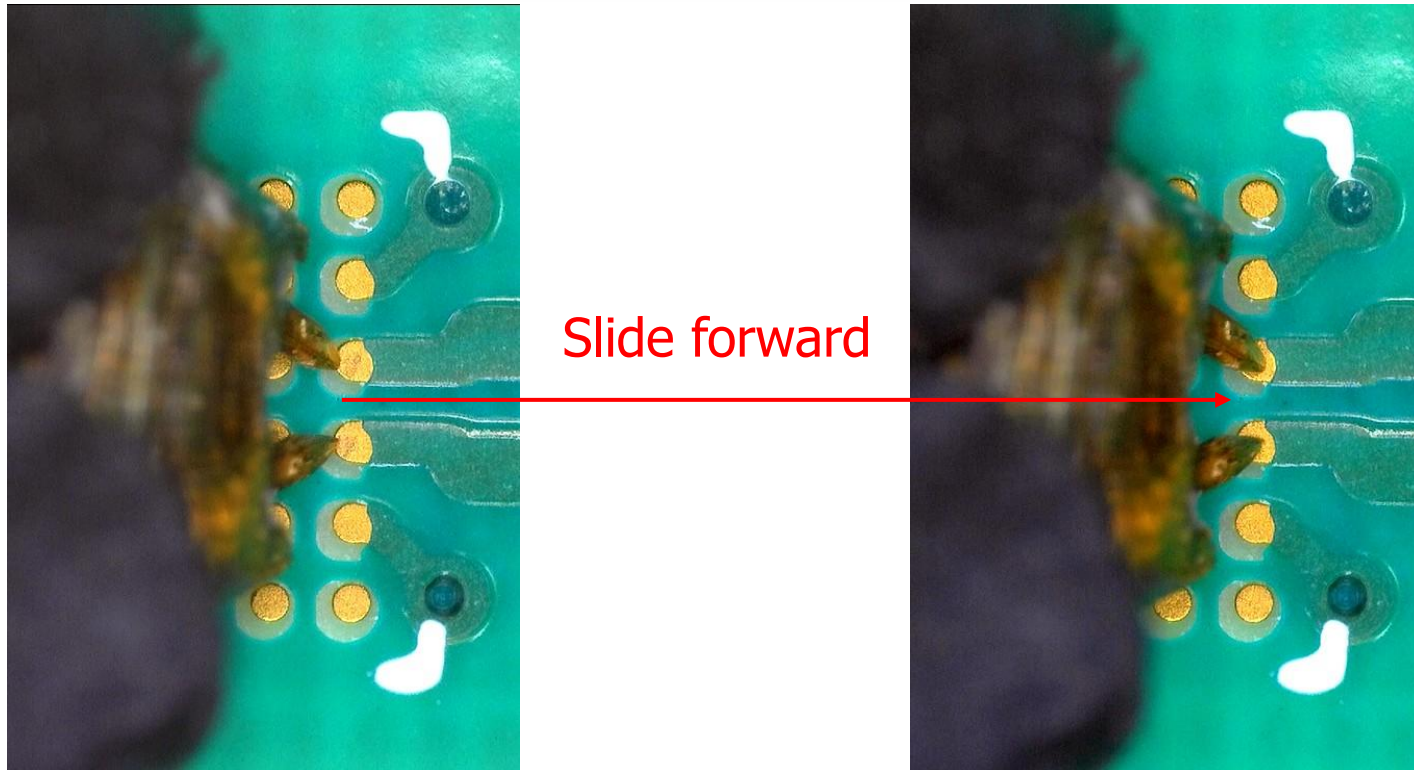
Both tips touch down simultaneously



Step 3:

Adjust the planarization knob on the positioner to land both probe tips. Above image shows the two probe tips touch the surface evenly.

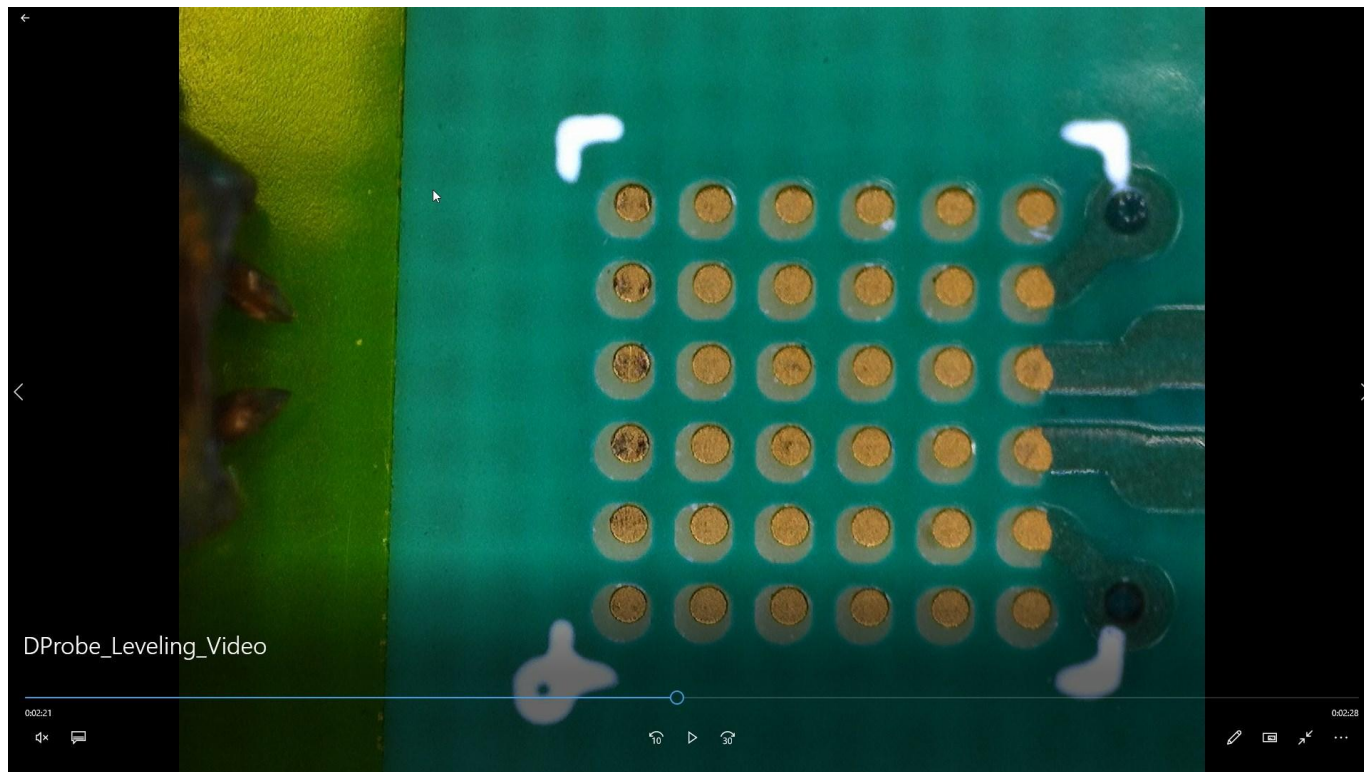
Make good probe contact on DUT



Step 4:

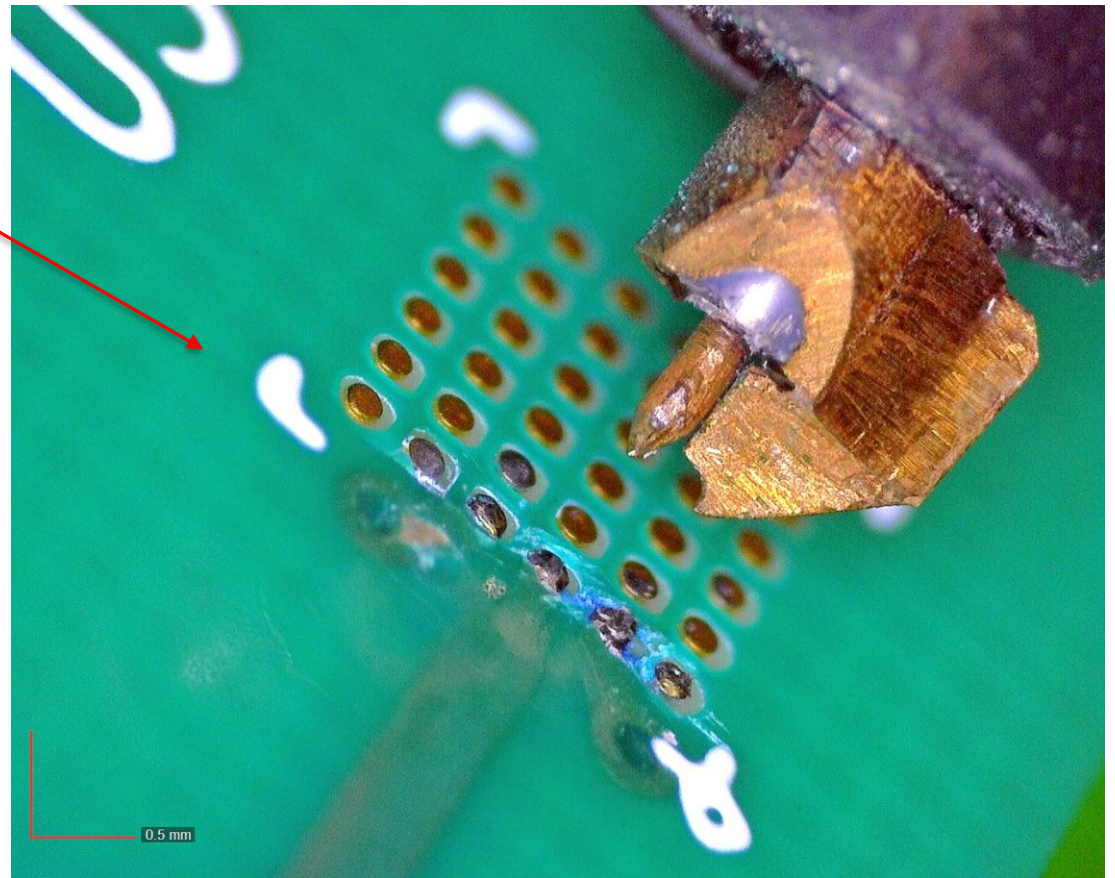
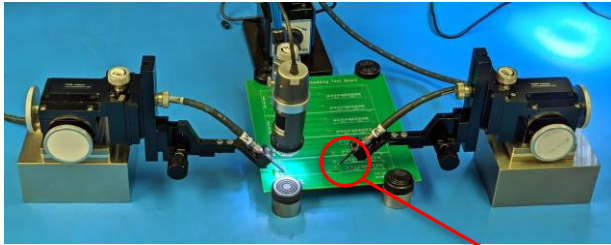
Lower the probe tips further and observe the tips to slide forward for 5 ~ 10 mils (125 ~ 250 μ m) for good probe contact

D-Probe Landing on BGA Pads



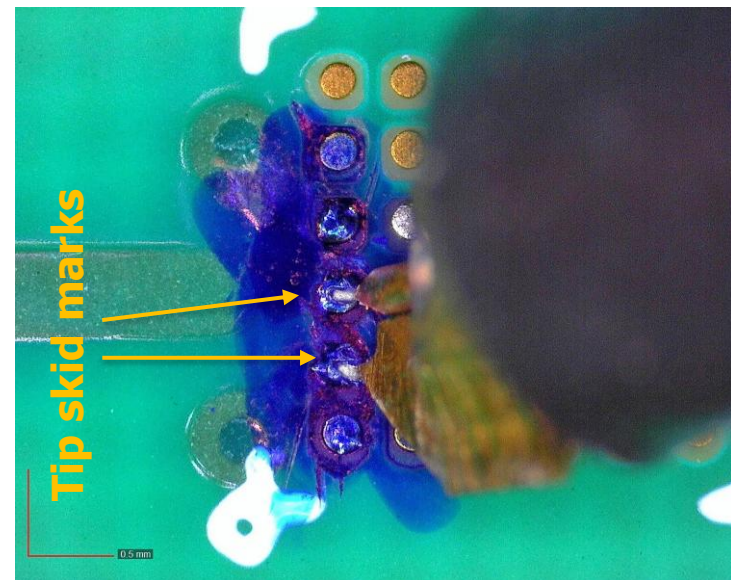
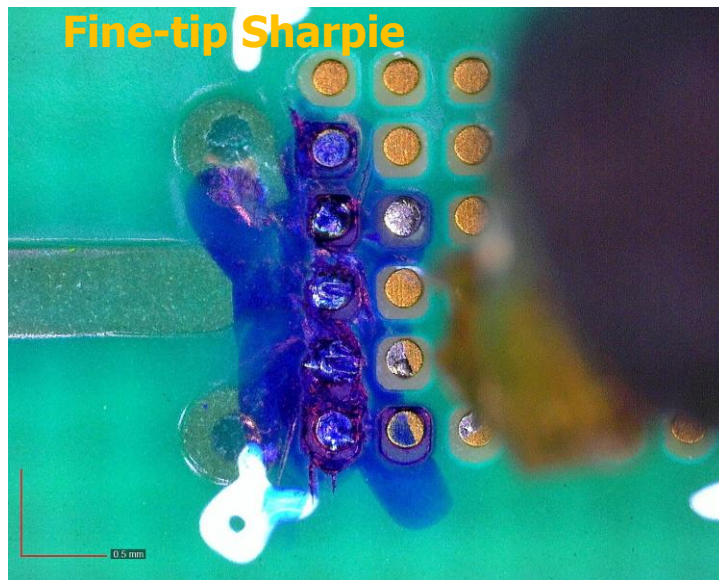
Video showing how to level the probe tips on a flat surface

Probe Planarization on Uneven Surface

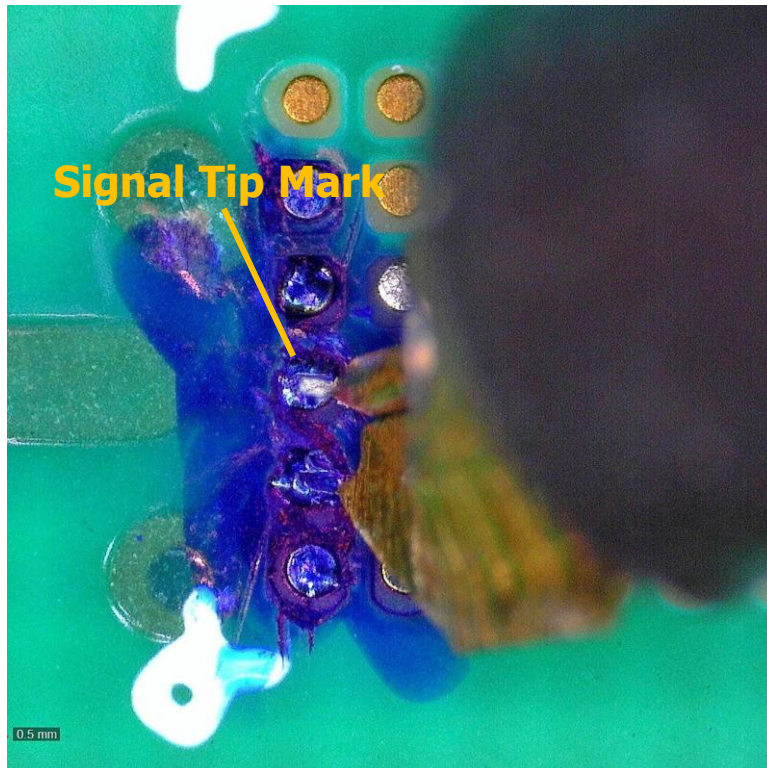


Land Probe Tips on Solder Bumps

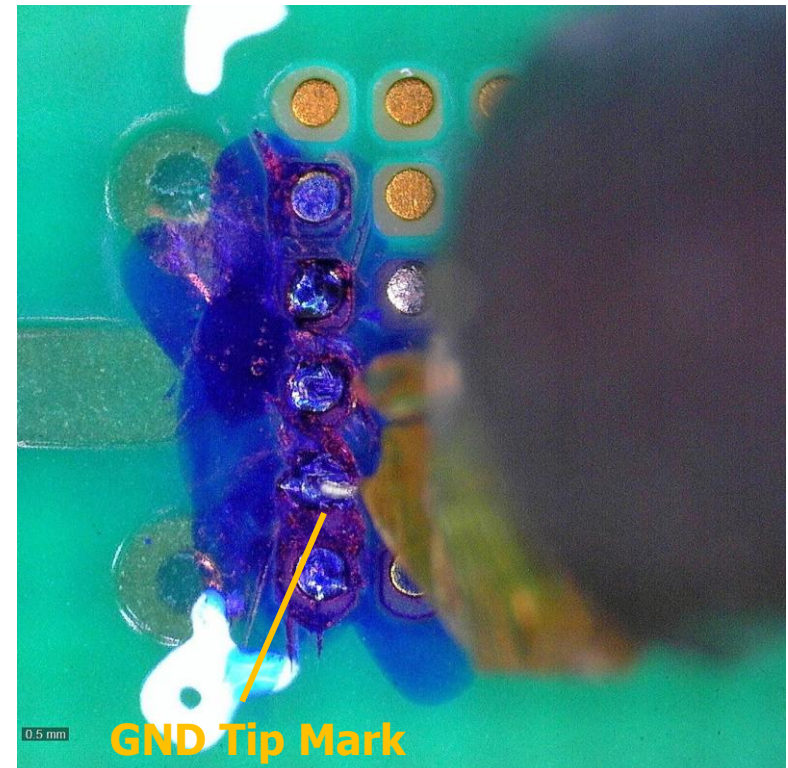
- Color solder bumps with a Sharpie
- Use the probe skid marks to confirm good tip contact
- Clean up the solder bumps with industrial alcohol after probing



Use Probe Skid Marks as Guidance

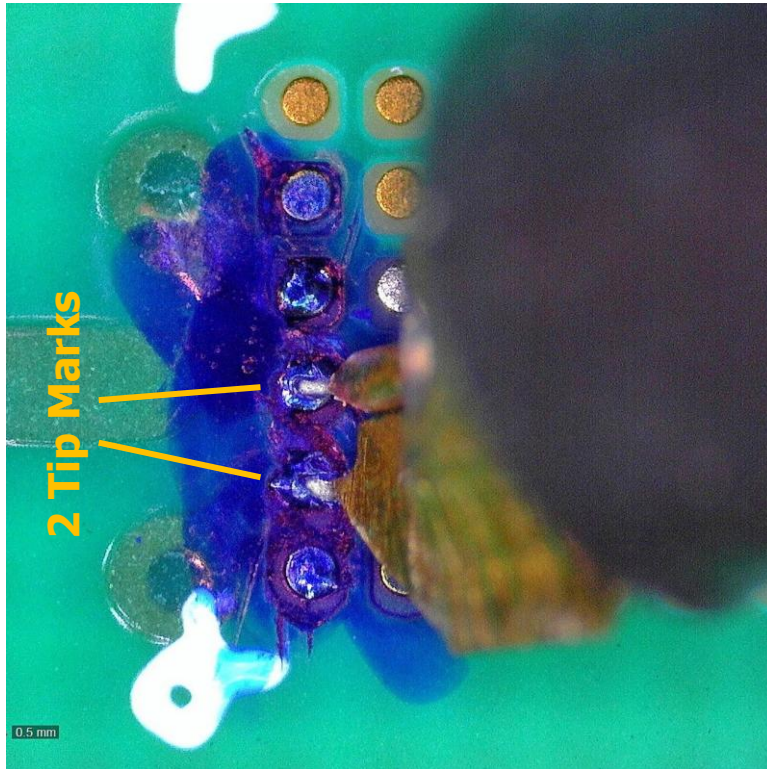


Top signal tip touches down first

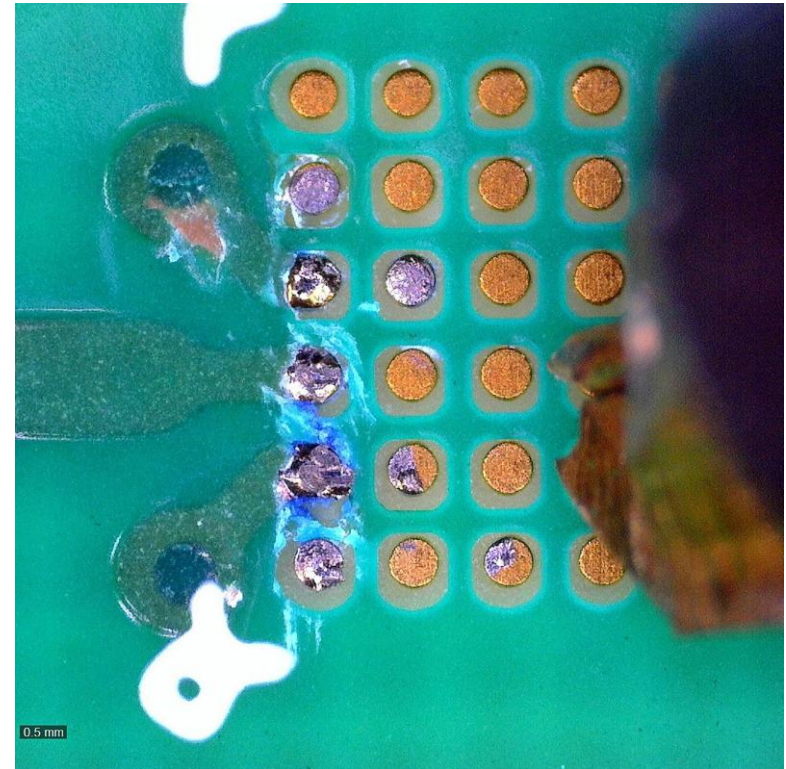


Bottom GND tip touches down first

Both Tips Touch Down Simultaneously

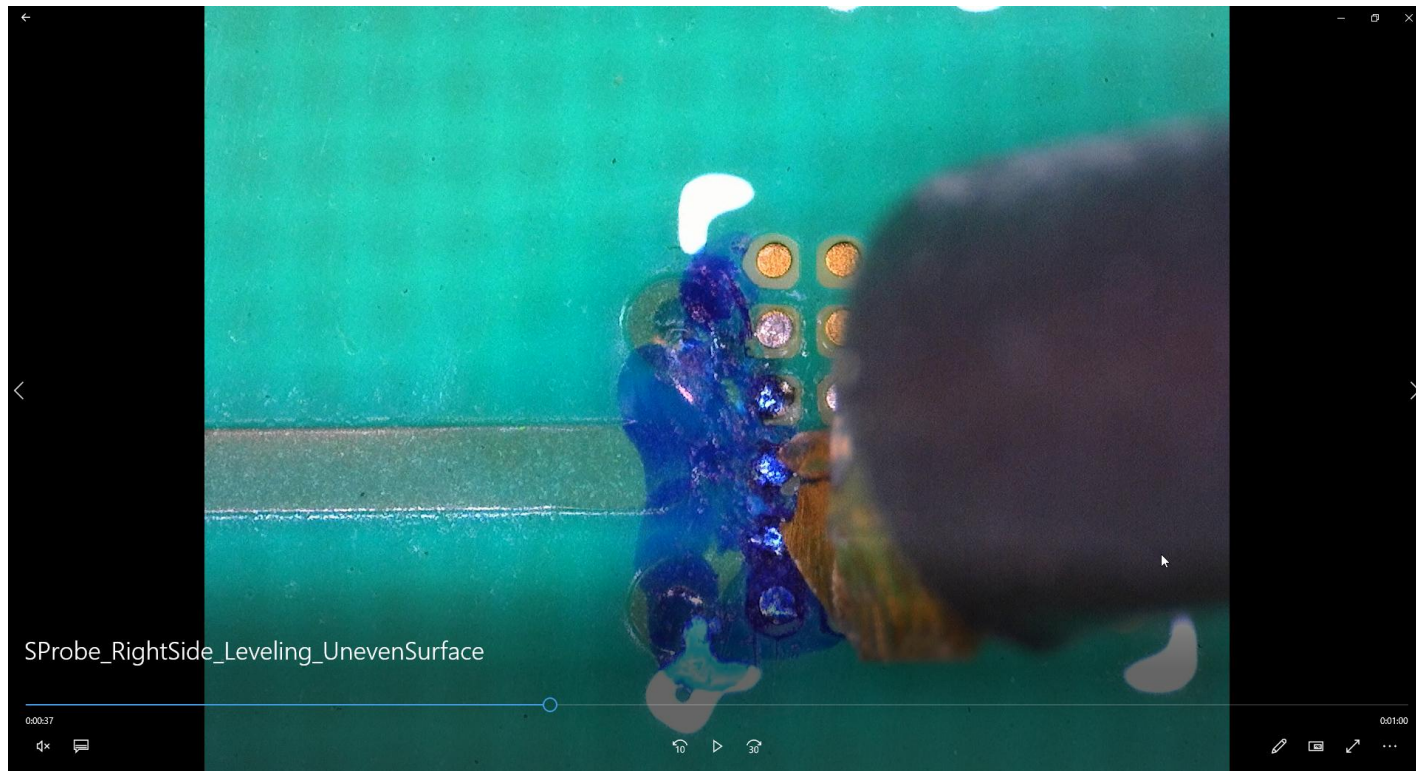


Both tips touch down simultaneously



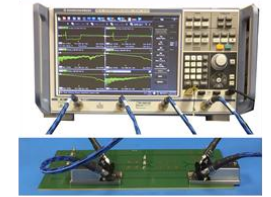
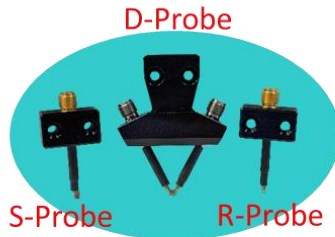
Clean up solder bumps with industrial alcohol after probing

S-Probe Landing on Solder Bumps

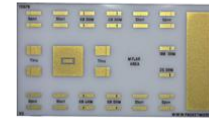


Video showing how to land the probe tips on an uneven surface

PacketMicro Product Offering



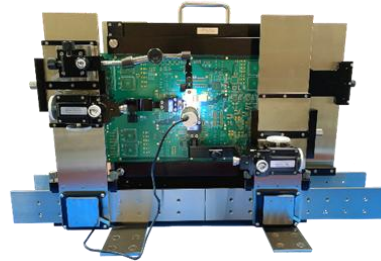
Delta-L 4.0 Solution



TCS70
Cal Substrate



VPS10 2-Sided Probe Station



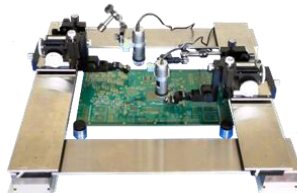
Flex Positioners



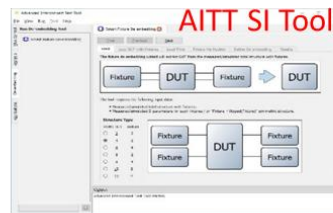
USB Type-C Fixtures



HPS24 Probe Station



AITT SI Tool



Slim Phase Stable Cable
Up to 67 GHz Junkosha MWX161



PacketMicro offers one-stop shopping for your needs in PCB probing and SI analysis.

- Rugged 40/30 GHz probes
- Probe Positioners
- DIY Probe Stations
- Junkosha phase-stable cables
- CSS AITT Signal-Integrity Tool
- Dino-Lite Microscopes

PacketMicro Customers (of 200+ in 30+ Countries)



Thank You

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- Rugged 30 GHz Single-ended Probes
- Laboratory Rental
- Engineering Services
- Signal Integrity Consulting

Contact:

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